5

206c can have a minimal thickness configured primarily as an electrically conductive shell for guiding power and data from the electronic device to which it couples and electrically conductive pathways within the accessory device. In some embodiments, electrical contacts 206a-206c can have 5 an average thickness of about 0.15 mm and be formed from a phosphorous bronze alloy. One reason the thickness of electrical contacts 206a-206c can be so thin is that the contacts are recessed when not in use which prevents un necessary wear and tear on electrical contacts 206a-206c. 10 Magnets 208a-208c can take the form of high-strength permanent magnets, such as rare-earth magnets along the lines of neodymium magnets. Magnets 208a-208c can have a size and shape complementary to an interior geometry of electrical contacts 206a-206c, so that magnets 208 can be 15 coupled with an interior volume defined by electrical contacts 206. In some embodiments, magnets 208 can be adhesively coupled to an interior surface of a corresponding

Connector 200 can also include a number of magnetic 20 shunts 210. Magnetic shunts 210 can be affixed to a rearfacing portion of a corresponding contact 206, thereby forming a number of floating contacts that each include contact 206, magnet 208 and magnetic shunt 210. Magnetic shunt 210 stays directly behind magnets 208 so that a 25 magnetic fields emitted by magnets 208 are concentrated towards openings 204 defined by protective cover 202. Magnetic shunts are generally made from a material resistance to the passage of magnetic fields. One common material utilized for magnetic shunts is stainless steel on 30 account of it being able to redirect magnetic fields that would otherwise pass through the magnetic shunt. The magnetic fields emitted by magnets 208 can be arranged in various polarity patterns that help to encourage proper lineup between the floating contacts and corresponding 35 contacts on a portable electronic device. For example, centrally positioned magnets could have one polarity and magnets arranged on the periphery could have an opposite direction polarity. These polarities could be matched with polarities associated with contacts of the portable electronic 40 device. It should be noted that in some embodiments, electrical contacts 206 can include a seal that interacts with protective cover 202 to prevent the intrusion of moisture into an associated accessory device through 200. For example, each of electrical contacts 206 can include an o-ring that 45 creates an interference fit with a portion of protective cover 202 at least when the floating contacts are in the recessed position.

The floating contacts can be soldered to solder pads on flexible printed circuit board (PCB) 212. The solder pads are 50 situated on portions of a flexible circuit taking the form of flexible PCB **212** that have been partially separated from the rest of flexible PCB 212. In this way, the portions of the flexible PCB upon which electrical contacts 206 are attached allow substantial movement of electrical contacts 206 away 55 from flexible PCB 212, so only minor amounts of stress are applied to flexible PCB 212 during movement of the floating contacts. By having three floating contacts, each of the floating contacts can be arranged to provide power, a ground or a data signal. When the central contact is associated with 60 power, connector 200 can be arranged to accept either a ground or a data signal at either of the peripheral contacts. In this way, connector 200 can be coupled to a portable electronic device in either of two different orientations. Flexible printed circuit board 212 can be adhesively coupled 65 with DC shield 214. FIG. 2B shows a connector 250 having a configuration similar to that shown in FIG. 2A with the

6

inclusion of a fourth contact depicted as contact **256***d*. In some embodiments, the fourth contact **256***d* can provide additional power for connector **250**. In other embodiments, the additional contact **256***d* can provide an additional data port for increasing a transmission speed of data through connector **250**.

FIG. 3A shows how the floating contacts are assembled together from electrical contact 206, magnet 208 and magnetic shunt 210. The arrows depicts how magnet 208 is inserted into a rear opening defined by electrical contact 206 and then how magnetic shunt 210 fits between multiple tails 302 of electrical contact 206. FIG. 3B shows the floating contacts assembled and how protrusions 304 of magnetic shunt 210 fit between each of a number of tails 302 of electrical contact 206. In some embodiments, electrical contact 206 can be adhesively coupled to both magnet 208 and magnetic shunt 210.

FIG. 3B also shows a detailed view of flexible PCB 212. Flexible PCB includes multiple electrically conductive pathways that couple the floating contacts with circuitry within the accessory device. Here it can be seen how flexible PCB 212 includes attachment features 306 that take the form of inner and outer rings of material of flexible PCB 212, which gives each of attachment features 306 a somewhat spiral shaped geometry. In particular, one of attachment features 306 includes outer ring 306(1)a and inner ring 306(1)b. Outer ring 306(1)a includes multiple solder pads 308 by which each attachment features 306 can be electrically and mechanically coupled with a floating contact and in particular with tails 302 of the floating contact. Outer ring 306(1)ais coupled to the rest of flexible PCB 212 by inner ring **306**(1)*b*, which is in turn attached to the rest of flexible PCB 212 by an attachment member that takes the form of a narrow strip of material. On account of attachment features 306 following a linear path that includes multiple turns, attachment features 306 can allow the floating contacts to transition between engaged and recessed positions while placing minimal stress on attachment features 306 and flexible PCB 212. This motion is accommodated primarily by the inner ring of each of attachment features 306 since the outer ring is soldered in four places to tails 302 of electrical contacts 206. When connector 200 transitions between recessed and engaged positions attachment features 306 undergo a telescoping action to accommodate the motion. It should also be noted that while each of attachment features **306** is depicted as being oriented in a different direction, that the flexible connectors could also each be oriented in the same direction or have their orientations vary in different amounts or patterns.

FIG. 3C shows a view of the floating contacts soldered to the solder pads arranged on attachment features 306 of flexible PCB 212. FIG. 3C also shows how flexible PCB 212 can be adhesively coupled with DC shield 214. DC shield can be formed from any number of magnetically attractable materials. In one particular embodiment DC shield 214 can be formed for stainless steel (SUS) 430. In another embodiment, DC shield 214 and magnetic shunts 210 can be formed of a cobalt iron alloy. It should be noted that in some embodiments only a periphery of flexible PCB 212 is coupled with DC shield 214, thereby allowing attachment features 306 to telescope away from DC shield 214 to accommodate movement of the floating contacts. Flexible PCB 212 can be coupled to DC shield 214 in many ways including by a layer of adhesive. In some embodiments, the layer of adhesive forms an insulating layer that electrically isolates flexible PCB 212 from DC shield 214.